

HD74LV245A

Octal Bus Transceivers with 3-state Outputs

REJ03D0329-0300Z (Previous ADE-205-247A (Z)) Rev.3.00 Jun. 24, 2004

Description

The HD74LV245A has eight buffers with three-state outputs in a 20-pin package. When DIR is high, data is transferred from the A inputs to the B outputs, and when DIR is low, data is transferred from the B inputs to the A outputs. The A and B buses are separated by making the enable input (\overline{OE}) high level. Low-voltage operation is suitable for battery-powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- $V_{CC} = 2.0 \text{ V to } 5.5 \text{ V operation}$
- All inputs V_{IH} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
- All outputs V_0 (Max.) = 5.5 V (@ V_{CC} = 0 V)
- Typical V_{OL} ground bounce < 0.8 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- Typical V_{OH} undershoot > 2.3 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- Output current ± 8 mA (@V_{CC} = 3.0 V to 3.6 V), ± 16 mA (@V_{CC} = 4.5 V to 5.5 V)

Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV245AFPEL	SOP-20 pin (JEITA)	FP-20DAV	FP	EL (2,000 pcs/reel)
HD74LV245ARPEL	SOP-20 pin (JEDEC)	FP-20DBV	RP	EL (1,000 pcs/reel)
HD74LV245ATELL	TSSOP-20 pin	TTP-20DAV	Т	ELL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

Function Table

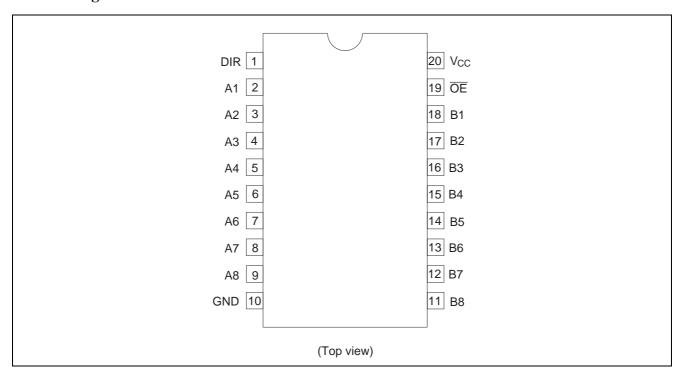
Inputs

ŌĒ	DIR	Operation
L	L	B data to A bus
L	Н	A data to B bus
Н	X	Isolation

Note: H: High level
L: Low level

X: Immaterial

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	Vcc	-0.5 to 7.0	V	
Input voltage range*1	Vı	-0.5 to 7.0	V	
Output voltage range*1, *2	Vo	-0.5 to V_{CC} + 0.5	V	Output: H or L
		-0.5 to 7.0		V _{CC} : OFF or Output: Z
Input clamp current	I _{IK}	-20	mA	V _I < 0
Output clamp current	I _{OK}	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	Io	±35	mA	$V_O = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±70	mA	
Maximum power dissipation at	P _T	835	mW	SOP
Ta = 25°C (in still air)*3		757		TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

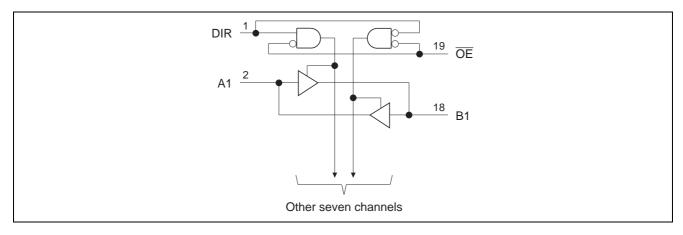
- 1. The input and output voltage ratings may be exceeded even if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The data above are measured by ΔV_{BE} method mounting on glass epoxy board (40 \times 40 \times 1.6 mm) with 10% of wiring density.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	Vcc	2.0	5.5	V	
Input voltage range	Vı	0	5.5	V	
Output voltage range	Vo	0	V _{CC}	V	Output: H or L
		0	5.5		High impedance state
Output current	I _{OH}	_	-50	μΑ	V _{CC} = 2.0 V
		_	-2	mA	V _{CC} = 2.3 to 2.7 V
		_	-8		V _{CC} = 3.0 to 3.6 V
		_	-16		V _{CC} = 4.5 to 5.5 V
	I _{OL}	_	50	μΑ	V _{CC} = 2.0 V
		_	2	mA	V _{CC} = 2.3 to 2.7 V
		_	8		V _{CC} = 3.0 to 3.6 V
		_	16		V _{CC} = 4.5 to 5.5 V
Input transition rise or fall rate	Δt /Δν	0	200	ns/V	V _{CC} = 2.3 to 2.7 V
		0	100		V _{CC} = 3.0 to 3.6 V
		0	20		V _{CC} = 4.5 to 5.5 V
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Logic Diagram



DC Electrical Characteristics

Ta = -40 to $85^{\circ}C$

Item	Symbol	V _{CC} (V)*1	Min	Тур	Max	Unit	Test Conditions
Input voltage	V_{IH}	2.0	1.5	_	_	V	
		2.3 to 2.7	$V_{CC} \times 0.7$	_	_		
		3.0 to 3.6	$V_{CC} \times 0.7$	_	_		
		4.5 to 5.5	$V_{CC} \times 0.7$	_	_		
	V _{IL}	2.0	_	_	0.5		
		2.3 to 2.7	_	_	$V_{\text{CC}} \times 0.3$		
		3.0 to 3.6	_	_	$V_{\text{CC}} \times 0.3$		
		4.5 to 5.5	_	_	$V_{CC} \times 0.3$		
Output voltage	V _{OH}	Min to Max	V _{CC} -0.1	_	_	V	$I_{OH} = -50 \mu A$
		2.3	2.0	_	_	<u></u>	$I_{OH} = -2 \text{ mA}$
		3.0	2.48	_	_		$I_{OH} = -8 \text{ mA}$
		4.5	3.8	_	_		$I_{OH} = -16 \text{ mA}$
	V _{OL}	Min to Max	_	_	0.1		$I_{OL} = 50 \mu A$
		2.3	_	_	0.4		I _{OL} = 2 mA
		3.0	_	_	0.44		$I_{OL} = 8 \text{ mA}$
		4.5	_	_	0.55		I _{OL} = 16 mA
Input current	I _{IN}	0 to 5.5	_	_	±1	μΑ	V _{IN} = 5.5 V or GND
Off-state output current	l _{OZ} * ²	5.5	_	_	±5	μΑ	$V_O = V_{CC}$ or GND
Quiescent supply current	I _{CC}	5.5	_	_	20	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Output leakage current	I _{OFF}	0	_	_	5	μΑ	V_1 or $V_0 = 0$ V to 5.5 V
Input capacitance	C _{IN}	3.3	_	3.0	_	pF	$V_I = V_{CC}$ or GND
Output capacitance	Co	3.3	_	5.5	_	pF	$V_O = V_{CC}$ or GND

Notes: 1. For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

^{2.} For I/O ports, the parameter I_{OZ} includes the input leakage current.

Switching Characteristics

 $V_{CC}=2.5\pm0.2~V$

		Ta =	25°C		Ta = -4	10 to 85°C		Test	FROM	то
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	8.3	13.0	1.0	15.0	ns	C _L = 15 pF	A or B	B or A
delay time	t _{PHL}	_	11.2	15.9	1.0	18.0	_	C _L = 50 pF		
Enable time	t _{zH}	_	11.8	19.9	1.0	22.0	ns	C _L = 15 pF	ŌĒ	A or B
	t_{ZL}	_	14.1	22.7	1.0	26.0		C _L = 50 pF	_	
Disable time	t _{HZ}	_	11.8	18.1	1.0	20.0	ns	C _L = 15 pF	ŌĒ	A or B
	t_{LZ}	_	17.6	23.1	1.0	25.0	_	C _L = 50 pF		

 $V_{CC}=3.3\pm0.3\ V$

		Ta =	25°C		Ta = -4	40 to 85°C		Test	FROM	то
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	5.9	8.4	1.0	10.0	ns	C _L = 15 pF	A or B	B or A
delay time	t _{PHL}	_	7.9	11.9	1.0	13.5		C _L = 50 pF		
Enable time	t _{zH}	_	8.2	13.2	1.0	15.5	ns	C _L = 15 pF	ŌĒ	A or B
	t_{ZL}	_	9.9	16.7	1.0	19.0	_	C _L = 50 pF		
Disable time	t _{HZ}	_	9.6	16.5	1.0	19.5	ns	C _L = 15 pF	ŌĒ	A or B
	t_{LZ}	_	13.9	19.8	1.0	22.0	_	C _L = 50 pF		

 $V_{CC}=5.0\pm0.5~V$

		Ta =	25°C		Ta = -4	40 to 85°C		Test	FROM	то
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	4.3	5.5	1.0	6.5	ns	C _L = 15 pF	A or B	B or A
delay time	t_{PHL}	_	5.6	7.5	1.0	8.5	_	C _L = 50 pF		
Enable time	t _{ZH}	_	5.7	8.5	1.0	10.0	ns	C _L = 15 pF	ŌĒ	A or B
	t_{ZL}	_	7.0	10.6	1.0	12.0	_	C _L = 50 pF	_	
Disable time	t _{HZ}	_	7.8	12.8	1.0	14.2	ns	C _L = 15 pF	ŌĒ	A or B
	t_{LZ}	_	10.9	14.7	1.0	16.0	_	C _L = 50 pF		

Output-skew Characteristics

 $C_L = 50 pF$

			Ta = 25°C		$Ta = -40 \text{ to } 85^{\circ}C$			
Item	Symbol	V _{CC} (V)	Min	Max	Min	Max	Unit	
Output skew	t _{sk (O)}	2.3 to 2.7	_	2.0	_	2.0	ns	
		3.0 to 3.6	_	1.5	_	1.5		
		4.5 to 5.5	_	1.0	_	1.0		

Note: Skew between any outputs of the same package switching in the same direction. This parameter is warranted but not production tested.

Operating Characteristics

 $C_L = 50 \text{ pF}$

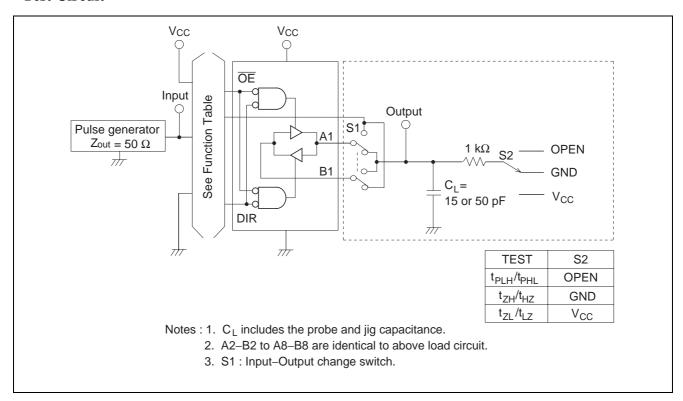
			Ta = 2	5°C			
ltem	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	C_{PD}	3.3	_	20.0	_	pF	f = 10 MHz
		5.0	_	25.0	_		

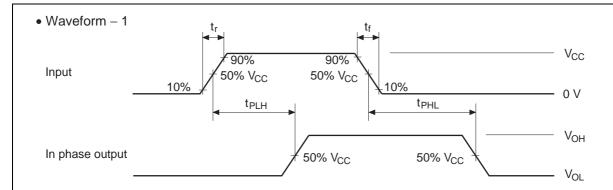
Noise Characteristics

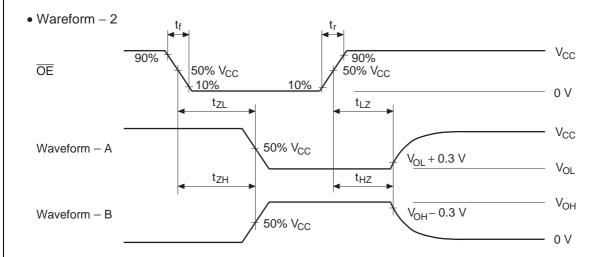
 $C_L = 50 pF$

			Ta = 25°C				
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test Conditions
Quiet output, maximum dynamic V _{OL}	V _{OL (P)}	3.3	_	0.5	0.8	V	
Quiet output, minimum dynamic V _{OL}	V _{OL (V)}	3.3	_	-0.4	-0.8	V	
Quiet output, minimum dynamic V _{OH}	$V_{OH\ (V)}$	3.3	_	2.9	_	V	
High-level dynamic input voltage	$V_{\text{IH }(D)}$	3.3	2.31	_	_	V	
Low level dynamic input voltage	V _{IL (D)}	3.3	_	_	0.99	V	

Test Circuit



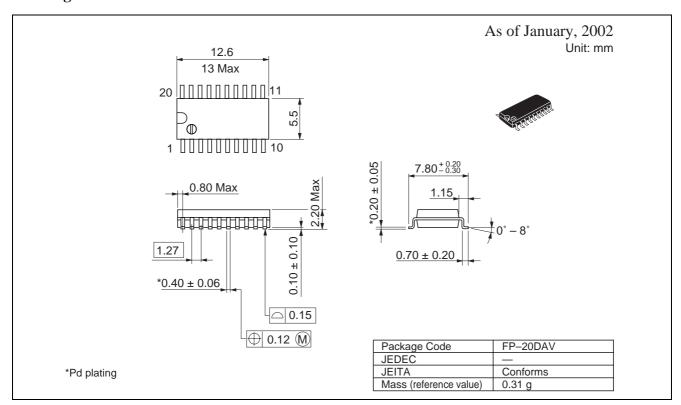


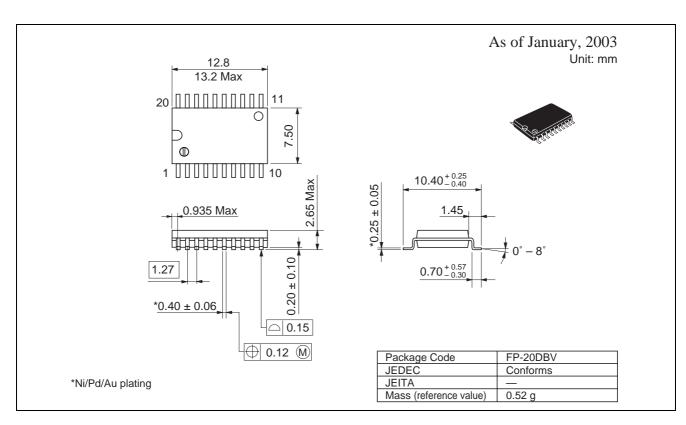


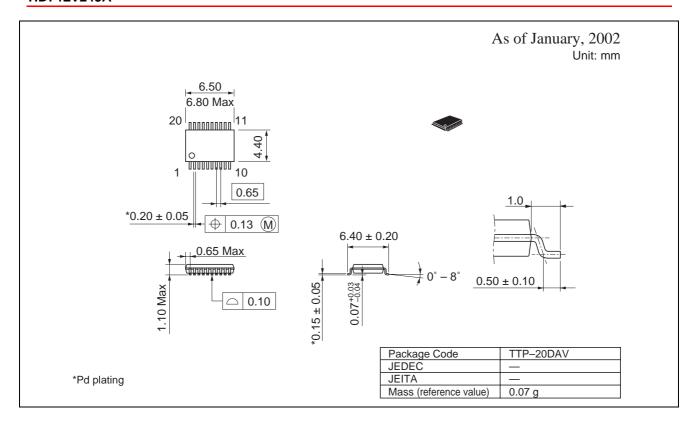
Notes: 1. Input waveform: PRR \leq 1 MHz, Zo = 50 Ω , $t_f \leq$ 3 ns, $t_f \leq$ 3 ns

- 2. Waveform–A is for an output with internal conditions such that the output is low except when disabled by the output control.
- 3. Waveform–B is for an output with internal conditions such that the output is high except when disabled by the output control.
- 4. The output are measured one at a time with one transition per measurement.

Package Dimensions







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Renesas Technology Singapore Pte. Ltd.
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